



[Back to results](#) | 1 of 1

[Download](#) [Print](#) [E-mail](#) [Save to PDF](#) [Add to List](#) [More... >](#)

Full Text (opens in a new window)

Journal of Physics: Conference Series • Open Access • Volume 2312, Issue 1 • 2022 • Article number 012046
• 3rd International Conference on Emerging Electrical Energy, Electronics and Computing Technologies 2021, ICE4CT
2021 • Virtual, Online • 16 December 2021 through 17 December 2021 • Code 181861

Document type

Conference Paper • Gold Open Access

Source type

Conference Proceedings

ISSN

17426588

DOI

10.1088/1742-6596/2312/1/012046

Publisher

Institute of Physics

Original language

English

[View less](#) ^

Cited by 0 documents

Inform me when this document
is cited in Scopus:

[Set citation alert >](#)

Related documents

Experimental study of micro-EDM on EN24 steel with normal brass, tin coated brass, cryogenic treated brass tool by varying the machining parameters

Krishnan, R. , Gnanasekaran, K. , Elil Raja, D.
(2022) *Materials Today: Proceedings*

Performance enhancement in WEDM of nitronic-30 using latent heat energy

Mohite, N.T. , Patil, G.V. , Kallol, A.N.
(2022) *Sadhana - Academy Proceedings in Engineering Sciences*

Analysis and Simulation of Temperature Distribution and Stress Development in Wire EDM of Tungsten Carbide

Awaludin, Ali Imran bin^a; Tomadi S.H.^a; Rosdi D.^b; Mas Ayu H.^c

 Save all to author list

^a Department of Manufacturing and Materials Engineering, Kulliyyah of Engineering, International Islamic University Malaysia, Selangor, Gombak, 53100, Malaysia

^b Faculty of Mechanical & Automotive Engineering Technology, Universiti Malaysia Pahang, Pahang, Pekan, 26600, Malaysia

^c Faculty of Manufacturing and Mechatronic Engineering Technology, Universiti Malaysia Pahang, Pahang, Pekan, 26600, Malaysia

A novel detecting and controlling strategy of the discharge status in high speed wire electrical discharge machining

Bai, J. , Huang, H. , Lu, Z. (2009) *Asia-Pacific Power and Energy Engineering Conference, APPEEC*

[View all related documents based on references](#)

[Find more related documents in Scopus based on:](#)

[Authors](#) > [Keywords](#) >

Abstract

Indexed keywords

Abstract

The main objectives of this research are to investigate the performance of temperature distribution and equivalent Von-Mises stress development on tungsten carbide, determine the effect of different machining parameters on the tungsten carbide workpiece, prepare a set of parameters, temperature distribution and stress development that can be compared with the experimental result and to optimize the machining parameters for machining tungsten carbide using wire EDM. However, wire EDM is a complicated stochastic nature process mechanism and it has a very large number of parameters that should be considered. It is quite hard to select the best set of parameters in experimenting. In this research, the Ansys software was used to simulate the maximum temperature and maximum equivalent (Von-Mises) stress result of machining the tungsten carbide by wire EDM. The input parameters selected in

conducting the simulation are pulse- on time and servo voltage. The wire diameter, convective coefficient, thermal expansion coefficient, current, thickness of the workpiece and wire material is taken as fixed parameters. By using Taguchi's L9 orthogonal array, the optimal value is obtained for maximum temperature and maximum equivalent (Von-Mises) stress . Additionally, the analysis of variance (ANOVA) is a useful technique to identify the most important factor that affecting the output response. © Published under licence by IOP Publishing Ltd.

Indexed keywords



References (7)

[View in search results format >](#)

All

[Export](#)

[Print](#)

[E-mail](#)

[Save to PDF](#)

[Create bibliography](#)

1 Naveed, R., Mufti, N.A.

Electric Discharge Machining of Tungsten Carbide using Uncoated and Coated Wire Electrodes: Analysis of Cutting Speed and Workpiece Geometrical Accuracy ([Open Access](#))

(2018) *IOP Conference Series: Materials Science and Engineering*, 409 (1), art. no. 012024. Cited 3 times.

<http://www.iop.org/EJ/journal/mse>

doi: 10.1088/1757-899X/409/1/012024

[View at Publisher](#)

- 2 Phiri, R.R., Oladijo, O.P., Akinlabi, E.T.
Tungsten carbide thin films Review: Effect of deposition parameters on film microstructure and properties ([Open Access](#))
(2019) *Procedia Manufacturing*, 35, pp. 522-528. Cited 2 times.
<http://www.journals.elsevier.com/procedia-manufacturing>
doi: 10.1016/j.promfg.2019.05.074
[View at Publisher](#)
-
- 3 Salvati, E., Korsunsky, A.M.
Micro-scale measurement & FEM modelling of residual stresses in AA6082-T6 Al alloy generated by wire EDM cutting
(2020) *Journal of Materials Processing Technology*, 275, art. no. 116373. Cited 27 times.
<https://www.journals.elsevier.com/journal-of-materials-processing-technology>
doi: 10.1016/j.jmatprotec.2019.116373
[View at Publisher](#)
-
- 4 Mohapatra, Kasinath Das, Sahoo, Susanta Kumar, Bhaumik, Munmun
Thermal Modeling and Structural Analysis in wire EDM Process for a 3D Model
(2016) *Applied Mechanics and Materials*, 852, pp. 279-289. Cited 4 times.
a b, c
-
- 5 Study and analysis of wire electrical discharge machining (wedm) through ansys and finite element method (FEM)
(2015) *International Journal of Engineering Research-Online*, 3, p. 4.

6 Mahapatra, S.S., Patnaik, A.

Optimization of wire electrical discharge machining (WEDM) process parameters using Taguchi method

(2007) *International Journal of Advanced Manufacturing Technology*, 34 (9-10), pp. 911-925. Cited 334 times.

doi: 10.1007/s00170-006-0672-6

[View at Publisher](#)

7 Sathiyaraj, S., Venkatesan, S., Ashokkumar, S., Senthilkumar, A.

Wire electrical discharge machining (WEDM) analysis into MRR and SR on copper alloy

(2020) *Materials Today: Proceedings*, Part 1 33, pp. 1079-1084.

<https://www-sciencedirect-com.ezlib.iium.edu.my/journal/materials-today-proceedings>

doi: 10.1016/j.matpr.2020.07.123

[View at Publisher](#)

© Copyright 2022 Elsevier B.V., All rights reserved.

About Scopus

[What is Scopus](#)

[Content coverage](#)

[Scopus blog](#)

[Scopus API](#)

[Privacy matters](#)

Language

[日本語版を表示する](#)

[查看简体中文版本](#)

[查看繁體中文版本](#)

[Просмотр версии на русском языке](#)

Customer Service

[Help](#)

[Tutorials](#)

[Contact us](#)

ELSEVIER

[Terms and conditions](#) ↗ [Privacy policy](#) ↗

Copyright © Elsevier B.V. ↗ All rights reserved. Scopus® is a registered trademark of Elsevier B.V.

We use cookies to help provide and enhance our service and tailor content. By continuing, you agree to the [use of cookies](#) ↗.

